

# **Z0**4

## 4 A Triacs

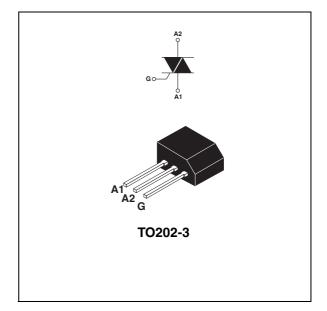
## **Main features**

Symbol	Value	Unit
I <sub>T(RMS)</sub>	4	A
V <sub>DRM</sub> /V <sub>RRM</sub>	600 to 800	V
I <sub>GT (Q1</sub> )	3 to 25	mA

## Description

The **Z04** series is suitable for general purpose AC switching applications. They can be found in applications such as home appliances (electrovalve, pump, door lock, small lamp control), fan speed controllers,...

Different gate current sensitivities are available, allowing optimized performances when controlled directly from microcontrollers.



## **Order codes**

Part Number	Marking
Z04xxyF <sup>(1)</sup>	Z04xxyF <sup>(1)</sup>

1. xx = sensitivity, y = voltage

### Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit			
1	DMC on state surrent (full size usus)		$T_{amb} = 25^{\circ} C$	4		
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave)	$T_{I} = 30^{\circ} C$		4	A	
	Non repetitive surge peak on-state current	F = 50 Hz	t = 20 ms	20	А	
I <sub>TSM</sub>	(full cycle, T <sub>j</sub> initial = 25° C)	F = 60 Hz	t = 16.7 ms	21		
l <sup>2</sup> t	l <sup>2</sup> t Value for fusing	t <sub>p</sub> = 10 ms		2.2	A <sup>2</sup> s	
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100$ ns	F = 120 Hz	T <sub>j</sub> = 125° C	20	A/µs	
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125° C	1.2	Α	
P <sub>G(AV)</sub>	Average gate power dissipation	0.2	W			
T <sub>stg</sub> T <sub>i</sub>	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 125	° C			

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# 1 Characteristics

Symbol	Test Conditions	Quadrant		Z04			Unit		
Symbol	Test conditions	Quadrant		02	05	09	10	UIII	
I <sub>GT</sub> <sup>(1)</sup>	V <sub>D</sub> = 12 V R <sub>I</sub> = 30 Ω	I - II - III - IV	MAX	3	5	10	25	mA	
V <sub>GT</sub>	VD - 12 V 11L - 30 32	ALL	MAX	1.3				V	
V <sub>GD</sub>	$ \begin{array}{l} V_D = V_{DRM}  R_L = 3.3 \ k\Omega \\ T_j = 125^\circ \ C \end{array} \hspace{1.5cm} ALL $		MIN.		0	.2		V	
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 50 mA		MAX	3	5	10	25	mA	
IL	l <sub>G</sub> = 1.2 l <sub>GT</sub>	I - III - IV	MAX	6	10	15	25	mA	
۰L	IG - 1.2 IG	II		12	15	25	50		
dV/dt <sup>(2)</sup>	$V_D = 6 \% V_{DRM}$ gate open $T_j = 110^{\circ} C$		MIN.	10	20	100	200	V/µs	
(dV/dt)c <sup>(2)</sup>	$(dI/dt)c = 1.8 \text{ A/ms}  T_j = 110$	°C	MIN.	0.5	1	2	5	V/µs	

### Table 2. Electrical Characteristics (Tj = 25° C, unless otherwise specified)

1. minimum IGT is guaranted at 5% of IGT max.

2. for both polarities of A2 referenced to A1.

### Table 3.Static Characteristics

Symbol	Test Co	Value	Unit		
V <sub>TM</sub> <sup>(1)</sup>	I <sub>TM</sub> = 5.5 A t <sub>p</sub> = 380 μs	$T_j = 25^\circ C$	MAX.	2.0	V
V <sub>to</sub> <sup>(1)</sup>	Threshold voltage	T <sub>j</sub> = 125° C	MAX.	0.95	V
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance	Dynamic resistance $T_j = 125^{\circ} C$ MAX.		180	mΩ
I <sub>DRM</sub>	V – V	$T_j = 25^\circ C$	MAX.	5	μA
I <sub>RRM</sub>	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125° C		0.5	mA

1. for both polarities of A2 referenced to A1.

### Table 4. Thermal resistances

Symbol	Parameter	Value	Unit
R <sub>th(j-l)</sub>	Junction to lead (AC)	15	° C/W
R <sub>th(j-a)</sub>	Junction to ambient	100	° C/W



#### Figure 1. Maximum power dissipation versus RMS on-state current (full cycle)

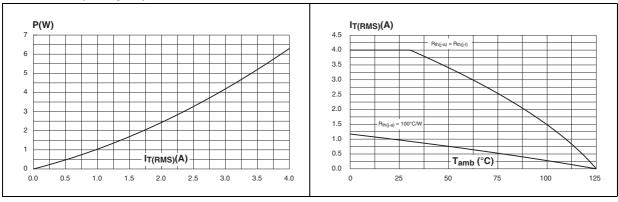


Figure 2.

Figure 3. **Relative variation of thermal** impedance versus pulse duration

Figure 4. Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

**RMS on-state current versus** 

ambient temperature (full cycle)

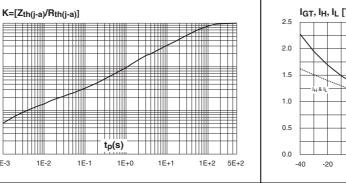


Figure 5. Surge peak on-state current versus number of cycles

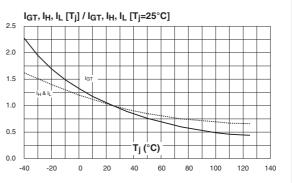
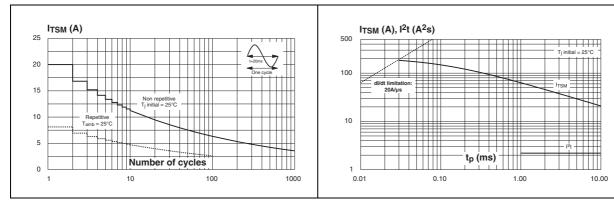


Figure 6. Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms and corresponding value of l<sup>2</sup>t





1E+0

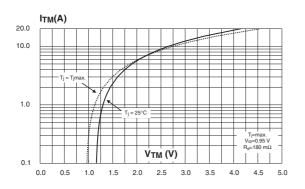
1E-1

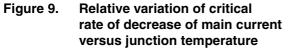
1E-2

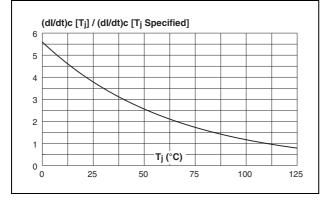
1E-3

1E-3

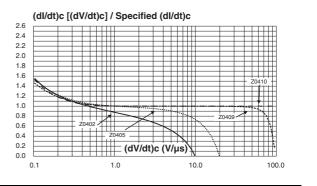
#### **On-state characteristics** Figure 7. (maximum values)







#### Figure 8. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)





# 2 Ordering information scheme

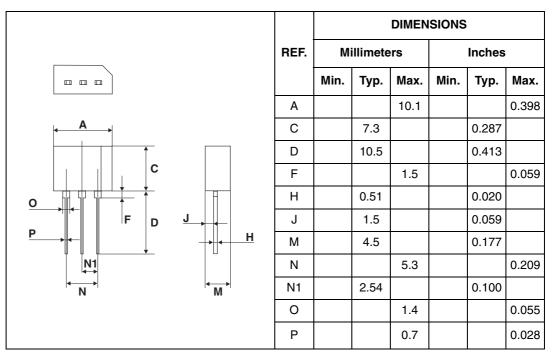
Triac series           Current           04 = 4A           Sensitivity           02 = 3mA           05 = 5mA           02 = 00 + 40	<b>Z</b>	04	xx	<b>y</b>	F	[BLANK]	0442
09 = 10mA 10 = 25mA							
Voltage           M = 600V           S = 700V           N = 800V							
Package F = TO202-3							
F = TO202-3       Packing mode       0AA2 = Tube							

## Table 5. Product selector

Part Number		Voltage	•	Consitivity	Tune	Deekere
Part Number	600 V	700 V	800 V	Sensitivity	Туре	Package
Z0402MF	Х			3 mA		
Z0402SF		Х		3 mA		
Z0402NF			Х	3 mA		
Z0405MF	Х			5 mA		
Z0405SF		Х		5 mA		
Z0405NF			Х	5 mA	Standard	TO202-3
Z0409MF	Х			10 mA	Stanuaru	10202-3
Z0409SF		Х		10 mA		
Z0409NF			Х	10 mA		
Z0410MF	Х			25 mA		
Z0410SF		Х		25 mA		
Z0410NF			Х	25 mA		



# 3 Package information



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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# 4 Ordering information

Ordering type	Ordering type Marking Weight		Base qty	Delivery mode
Z04xxyF 0AA2 <sup>(1)</sup>	Z04xxyF <sup>(1)</sup>	0.8 g	50	Tube

1. xx = sensitivity, y = voltage

# 5 Revision history

Date	Revision	Description of Changes
Oct-2001	4	Last update.
13-Feb-2006	5	TO202-3 delivery mode changed from bulk to tube. ECOPACK statement added.
31-Mar-2006	6	Reformatted to current standard. Lead marking changed on page 1
12-05-2006	7	Typographical error for (dV/dt)c corrected in Table 2.



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